

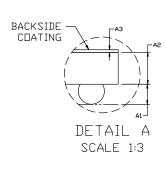


WLCSP15, 1.34x1.99x0.548 CASE 567GB ISSUE D

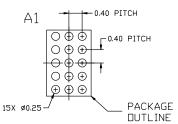
DATE 02 JUN 2022

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION 6 IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER PARALLEL TO DATUM C.
- 4. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 5. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



DIM	MILLIMETERS			
INITU	MIN.	N□M.	MAX.	
Α	0.498	0.548	0.598	
A1	0.178	0.203	0.228	
A2	0.295	0.320	0.345	
А3	0.025 BSC			
b	0.233	0.263	0.293	
D	1.34 BSC			
Е	1.99 BSC			
е	0.40 BSC			

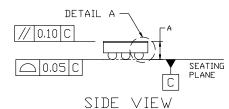


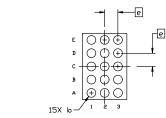
RECOMMENDED MOUNTING FOOTPRINT*

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

PIN 1 REFERENCE 2X 0.10C 2X 0.10C

TOP VIEW





0.05 M C A B 0.03 M C

BOTTOM VIEW

GENERIC MARKING DIAGRAM*



A = Assembly Location

L = Wafer Lot

Y = Year

W = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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